## MCD44-16io1B

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 $= 2 \times 1600 \text{ V}$ 

49 A

1.34 V

# **Thyristor \ Diode Module**

Phase I	eg
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Part number

MCD44-16io1B

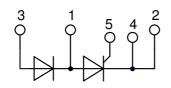


 $V_{RRM}$ 

I TAV

VT

Backside: isolated **E**72873



### Features / Advantages:

- Thyristor for line frequency
- Planar passivated chip
- Long-term stability
- Direct Copper Bonded Al2O3-ceramic

### **Applications:**

- Line rectifying 50/60 Hz
- Softstart AC motor control
- DC Motor control
- Power converter
- AC power control
- Lighting and temperature control

### Package: TO-240AA

- Isolation Voltage: 3600 V~
- Industry standard outline
- RoHS compliant
- Soldering pins for PCB mounting
- Base plate: DCB ceramic
- Reduced weight
- Advanced power cycling

### Terms Conditions of usage:

The data contained in this product data sheet is exclusively intended for technically trained staff. The user will have to evaluate the suitability of the product for the intended application and the completeness of the product data with respect to his application. The specifications of our components may not be considered as an assurance of component characteristics. The information in the valid application- and assembly notes must be considered. Should you require product information in excess of the data given in this product data sheet or which concerns the specific application of your product, please contact your local sales office. Due to technical requirements our product may contain dangerous substances. For information on the types in question please contact your local sales office. Should you intend to use the product in aviation, in health or life endangering or life support applications, please notify. For any such application we urgently recommend

to perform joint risk and quality assessments;
the conclusion of quality agreements;

- to establish joint measures of an ongoing product survey, and that we may make delivery dependent on the realization of any such measures.

IXYS reserves the right to change limits, conditions and dimensions.

Data according to IEC 60747and per semiconductor unless otherwise specified

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# MCD44-16io1B

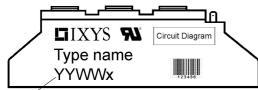
<b>.</b>		• ····		1	Ratings	1	
Symbol	Definition	Conditions		min.	typ.	max.	Uni
V <sub>RSM/DSM</sub>	max. non-repetitive reverse/forwa	0 0	$T_{VJ} = 25^{\circ}C$			1700	\
V <sub>RRM/DRM</sub>	max. repetitive reverse/forward bl		$T_{VJ} = 25^{\circ}C$			1600	١
R/D	reverse current, drain current	$V_{R/D} = 1600 V$	$T_{vJ} = 25^{\circ}C$			100	μ/
		V <sub>R/D</sub> = 1600 V	$T_{vJ} = 125^{\circ}C$			5	m/
V <sub>T</sub>	forward voltage drop	$I_{T} = 100 \text{ A}$	$T_{vJ} = 25^{\circ}C$			1.34	١
		$I_{T} = 200 \text{ A}$				1.75	١
		$I_{T} = 100 \text{ A}$	$T_{vJ} = 125^{\circ}C$			1.34	١
		I <sub>T</sub> = 200 A				1.80	١
ITAV	average forward current	$T_c = 85^{\circ}C$	$T_{vJ} = 125^{\circ}C$			49	1
I T(RMS)	RMS forward current	180° sine				77	1
V <sub>T0</sub>	threshold voltage		T <sub>v.i</sub> = 125°C			0.85	١
r <sub>T</sub>	slope resistance } for power lo	oss calculation only				5.3	m۵
<b>R</b> <sub>thJC</sub>	thermal resistance junction to cas	e				0.53	K/W
R <sub>thCH</sub>	thermal resistance case to heatsi				0.20		K/W
P <sub>tot</sub>	total power dissipation		$T_c = 25^{\circ}C$			180	W
I <sub>TSM</sub>	max. forward surge current	t = 10 ms; (50 Hz), sine	$T_{v,i} = 45^{\circ}C$			1.15	k/
•15M		t = 8,3 ms; (60 Hz), sine	$V_{\rm R} = 0 V$			1.24	k/
		t = 0,0  ms; (50  Hz),  sine	$T_{\rm H} = 0.0$ $T_{\rm VI} = 125^{\circ}{\rm C}$			980	1.0
		t = 8,3  ms; (60  Hz),  sine	$V_{\rm R} = 0 V$			1.06	, k/
l²t	value for fusing	t = 0.5  ms; (50  Hz),  sine t = 10  ms; (50  Hz),  sine	$\frac{v_{R}}{T_{VI}} = 45^{\circ}C$			6.62	
1-1	value for rusing					6.40	1
		t = 8,3 ms; (60 Hz), sine	$\frac{V_{R} = 0 V}{T_{R} + 105 \circ C}$				
		t = 10 ms; (50 Hz), sine	$T_{vJ} = 125 ^{\circ}C$			4.80	
		t = 8,3 ms; (60 Hz), sine	$V_{\rm R} = 0 V$		54	4.63	
C,	junction capacitance	$V_{\rm R} = 400  \text{V}  \text{f} = 1  \text{MHz}$	$T_{VJ} = 25^{\circ}C$		54		pl
P <sub>GM</sub>	max. gate power dissipation	t <sub>P</sub> = 30 μs	$T_c = 125^{\circ}C$			10	W
		t <sub>P</sub> = 300 μs				5	W
P <sub>GAV</sub>	average gate power dissipation					0.5	N
(di/dt) <sub>cr</sub>	critical rate of rise of current		epetitive, $I_{T} = 150 \text{ A}$			150	A/μ
		$t_{P}$ = 200 µs; di <sub>G</sub> /dt = 0.45 A/µs; -					 
		$I_{G} = 0.45 \text{ A}; \text{ V} = \frac{2}{3} \text{ V}_{DRM}$ no	on-repet., $I_{T} = 49 \text{ A}$			500	A/μ
(dv/dt) <sub>cr</sub>	critical rate of rise of voltage	$V = \frac{2}{3} V_{DRM}$	$T_{vJ} = 125^{\circ}C$			1000	V/µ
		$R_{GK} = \infty$ ; method 1 (linear volta	ge rise)				
V <sub>GT</sub>	gate trigger voltage	$V_{D} = 6 V$	$T_{vJ} = 25^{\circ}C$			1.5	١
			$T_{vJ} = -40 ^{\circ}\text{C}$			1.6	١
I <sub>GT</sub>	gate trigger current	$V_{D} = 6 V$	$T_{VJ} = 25^{\circ}C$			100	m/
			$T_{vJ} = -40 ^{\circ}\text{C}$			200	m/
V <sub>gd</sub>	gate non-trigger voltage	$V_{\rm D} = \frac{2}{3} V_{\rm DBM}$	T <sub>vJ</sub> = 125°C			0.2	١
I <sub>GD</sub>	gate non-trigger current					10	m/
	latching current	t <sub>p</sub> = 10 μs	$T_{vJ} = 25 ^{\circ}C$			450	m/
	5	$I_{\rm g} = 0.45 \text{A};  \text{di}_{\rm g}/\text{dt} = 0.45 \text{A}/\mu\text{s}$					
I <sub>H</sub>	holding current	$V_{\rm D} = 6  \text{V}  \text{R}_{\rm GK} = \infty$	T <sub>vJ</sub> = 25°C			200	m/
	gate controlled delay time	$V_{\rm D} = \frac{1}{2} V_{\rm DRM}$	$T_{VJ} = 25 ^{\circ}\text{C}$			200	i
t <sub>gd</sub>	gate controlled delay lille					2	μ
		$I_{\rm G} = 0.45 \text{A};  \text{di}_{\rm G}/\text{dt} = 0.45 \text{A}/\mu\text{s}$ $V_{\rm R} = 100 \text{V};  I_{\rm T} = 120 \text{A};  \text{V} = 3$					μ
tq	turn-off time				150		

 $\ensuremath{\mathsf{IXYS}}$  reserves the right to change limits, conditions and dimensions.

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# MCD44-16io1B

Package TO-240AA				Ratings				
Symbol	Definition	Conditions			min.	typ.	max.	Unit
	RMS current	per terminal					200	Α
T <sub>vj</sub>	virtual junction temperature				-40		125	°C
T <sub>op</sub>	operation temperature				-40		100	°C
T <sub>stg</sub>	storage temperature				-40		125	°C
Weight						81		g
M <sub>D</sub>	mounting torque				2.5		4	Nm
M <sub>T</sub>	terminal torque				2.5		4	Nm
d <sub>Spp/App</sub>			terminal to terminal	13.0	9.7			mm
<b>d</b> <sub>Spb/Apb</sub>	creepage distance on suna	creepage distance on surface   striking distance through air		16.0	16.0			mm
V	isolation voltage	t = 1 second			3600			V
		t = 1 minute	50/60 Hz, RMS; liso∟ ≤ 1 mA		3000			V



Date Code

Ordering	Ordering Number	Marking on Product	Delivery Mode	Quantity	Code No.
Standard	MCD44-16io1B	MCD44-16io1B	Box	36	497630

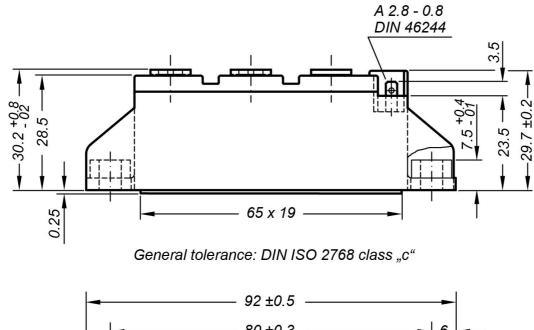
Similar Part	Package	Voltage class
MCMA50PD1600TB	TO-240AA-1B	1600
MCMA65PD1600TB	TO-240AA-1B	1600

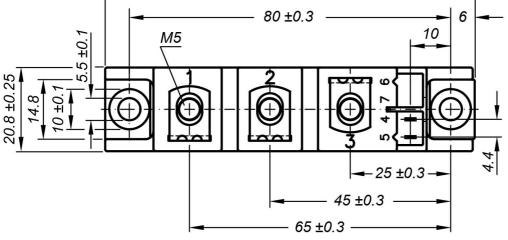
Equiva	lent Circuits for	Simulation	* on die level	T <sub>vj</sub> = 125 °C
	⊢R₀−	Thyristor		
V <sub>0 max</sub>	threshold voltage	0.85		V
$\mathbf{R}_{0 \text{ max}}$	slope resistance *	4.1		mΩ

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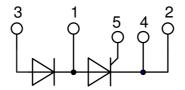
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## Outlines TO-240AA





Optional accessories: Keyed gate/cathode twin plugs Wire length: 350 mm, gate = white, cathode = red UL 758, style 3751 Type **ZY 200L** (L = Left for pin pair 4/5)



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sin

150

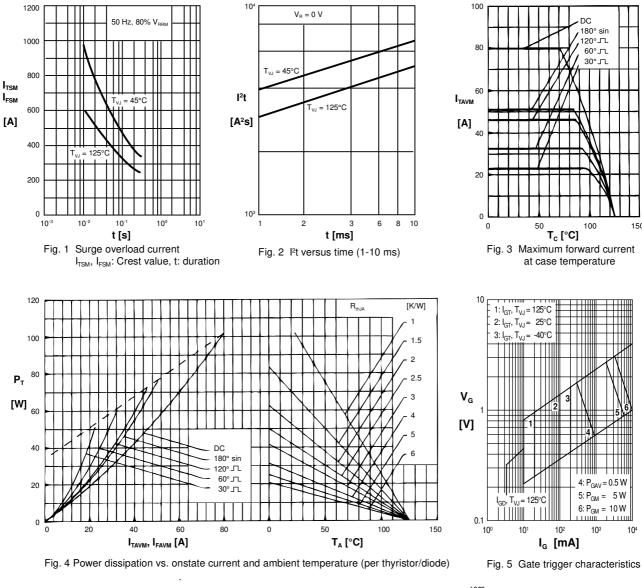
= 0.5 W

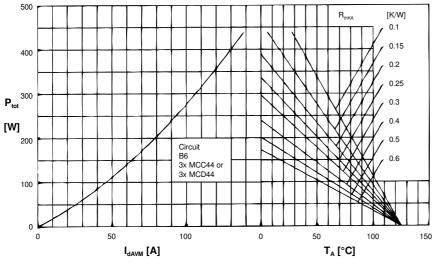
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### Thyristor





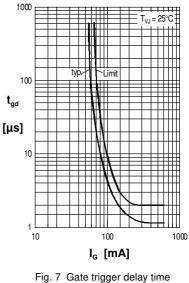
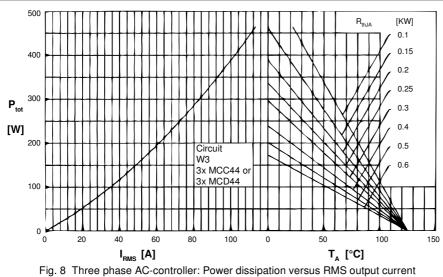


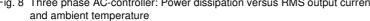
Fig. 6 Three phase rectifier bridge: Power dissipation versus direct output current and ambient temperature

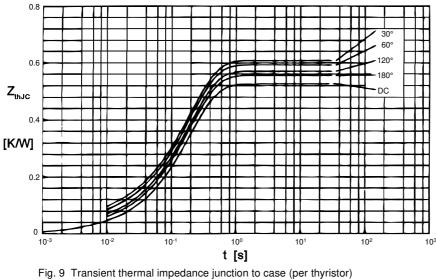
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# MCD44-16io1B

## Rectifier







	un -		
Ħ	1 0.01	5 0.0035	
Ŧ	2 0.02	.0200	
10 <sup>3</sup>	3 0.48	9 0.1950	
П	R <sub>thJK</sub> for va	arious conduction angl	es d:
44	d	R <sub>thJK</sub> [K/W]	
	DC	0.73	
П	180°	0.75	
Ħ	120°	0.78	
+1	60°	0.80	
	30°	0.82	
Π	•		
Ħ	Constants	for $Z_{thJK}$ calculation:	
41	i R <sub>thi</sub> [K/	/W] t <sub>i</sub> [s]	
11	1 0.01	F 0.000F	

1	0.015	0.0035
2	0.026	0.0200
3	0.489	0.0195
4	0.200	0.6800

1.0

60 0.8 20  $\mathsf{Z}_{\mathsf{thJK}}$ 180° DC 0.6 [K/W] 0.4 0.2 0 10-3 10<sup>-2</sup> 10-100 10 10<sup>2</sup> 10<sup>3</sup> t [s] Fig. 10 Transient thermal impedance junction to heatsink (per thyristor)

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d	R <sub>thJC</sub> [K/W]
DC	0.53
180°	0.55
120°	0.58
60°	0.60
30°	0.62
Constants i R <sub>thi</sub> [K	s for Z <sub>thJC</sub> calculatio ( <b>/W] t<sub>i</sub> [s]</b>

 $\mathbf{R}_{_{\text{thJC}}}$  for various conduction angles d:

Constants for	${\rm Z}_{\rm thJC}$	calculation:

I	R <sub>thi</sub> [K/W]	t <sub>i</sub> [s]
1	0.015	0.0035
2	0.026	0.0200
3	0.489	0.1950
-		



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